

NM7010B⁺

| No. | COUNT | LOCATION | DESCRIPTION | ASSORTMENT | Mfg. |
|-----|-------|--------------------------|--|-----------------------|----------|
| 1 | 1 | CP1 | 22uF CTYPE(6032) 20% 16V | CAP-TANTAL | |
| 2 | 1 | CP2 | 2.2uF ATYPE(3216) 10V | CAP-TANTAL | |
| 3 | 1 | CP3 | 10uF ATYPE(3216) 10V | CAP-TANTAL | |
| | | C1,C2,C3,C4,C5,C6,C7,C8 | | | |
| | | ,C9,C10,C11,C12,C14,C15, | | | |
| 4 | 17 | C17,C18,C19 | 0.1uF 1608 20% 50V | CAP-CHIP | |
| 5 | 2 | C13,C16 | 20pF 1608 20% 50V | CAP-CHIP | |
| 6 | 1 | D1 | 1SS181 Switching Diode SOT-23 | DIODE | |
| 7 | 2 | JP2,JP1 | 87089-2816 2X14 28PIN 2mm DIP STRAIGHT | HEADER | MOLEX |
| 8 | 2 | L3,L1 | HB-1M1608-121 120R @ 100MHz 2012 0.12R 300mA | BEAD-CHIP | CERATECH |
| 9 | 1 | L2 | FI-B2012-472KJP 4.7uH | Inductor-CHIP | CERATECH |
| 10 | 1 | R4 | 1K 1608 5% 1/10W | RES-CHIP | |
| 11 | 1 | R6 | 1.5K 1608 5% 1/10W | RES-CHIP | |
| 12 | 1 | R8 | 2K 1608 1% 1/10W | RES-CHIP | |
| 13 | 2 | R12,R3 | 200R 1608 5% 1/10W | RES-CHIP | |
| 14 | 4 | R5,R7,R9,R11 | 51R 1608 1% 1/10W | RES-CHIP | |
| 15 | 1 | R10 | 4.7K 1608 5% 1/10W | RES-CHIP | |
| 16 | 2 | R1,R2 | 4.7K 3216 CONVEX 5% 50V | RES-CHIP-ARRAY | |
| 17 | 1 | U1 | W3150A ⁺ | IC-TCP/IP | WIZNET |
| 18 | 1 | U3 | RTL8201CP LQFP48 PHY | IC-PHY | REALTEK |
| 19 | 1 | U2 | RD1-125BAG1A MAG-JACK | CONNECTOR-RJ45 | UDE |
| 20 | 1 | Y1 | ATS25/U 25MHz ATS Holder Type | CRYSTAL | SUNNY |
| 21 | 1 | | NM7010B+ REV1.0 FR4 1.6T 4LAYER | PRINTED CIRCUIT BOARD | |